

PCN# 20200728003.1 Die Coating material change for select devices Change Notification / Sample Request

Date: July 31, 2020 To: PREMIER FARNELL PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

CUSTOMER PART NUMBER

DEVICE LM4040AIM3-2.5/NOPB LM4040BIM3-2.5/NOPB LM4040CIM3-2.5/NOPB LM4040CIM3X-2.5/NOPB LM4040DIM3-2.5/NOPB LM4040DIM3X-2.5/NOPB

null null null null null null

Technical details of this Product Change follow on the next page(s).

PCN Number	:	2020	0728003.1		PCN D	ate:	Jul 31, 20	20	
Title: Di	e Coating n	nateria	I change for Select D	evices					
Customer Contact:		F	PCN Manager		Dept:		Quality Services		
Proposed 1 st Ship Date:			Oct 31, 2020		Estimated Sample Availability:			Date provided at sample request.	
Change Type									
Assembly Site			Assembly Process					sembly Materials	
Design			Electrical Specification				Mechanical Specificat		
Test Site			Packing/Shipping/Labeling				est Process /afer Bump Process		
Wafer Bump Site Wafer Fab Site			Wafer Bump Material Wafer Fab Materials				Wafer Fab Process		
			Part number cha						
			PCN De						
Description of									
listed in "Produ	uct Affected	d" secti		county					
	Chang	e Fron	n	Change To					
	NC	NONE			POLYIMIDE				
_		in the	Qual Data Section.						
Qual details ar Reason for C Manufacturing	hange:		Qual Data Section.						
Reason for C Manufacturing	hange: Enhancem	ent	Qual Data Section. Fit, Function, Qual	lity or Re	liability	(pos	itive / nega	tive):	
Reason for C Manufacturing Anticipated i	hange: Enhancem	ent		lity or Re	liability	(pos	itive / nega	tive):	
Reason for C Manufacturing Anticipated i None	hange: Enhancem mpact on	ent Form,		-	-	(pos	itive / nega	tive):	
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Reason for C Manufacturing Anticipated i None Changes to p None	hange: Enhancem mpact on l roduct ide	ent Form, entifica	Fit, Function, Qual	n this PC	-			tive):	
Reason for C Manufacturing Anticipated i None Changes to p None Product Affee	hange: Enhancem mpact on roduct ide cted: 2.5	ent Form, entifica	Fit, Function, Qual	n this PC 01881	N: LM4040	DIM3-2		tive):	
Reason for C Manufacturing Anticipated i None Changes to p None Product Affee LM4040AIM3-2	hange: Enhancem mpact on l roduct ide cted: 2.5 2.5/NOPB	ent Form, entifica	Fit, Function, Qual ation resulting from LM4040CEM3-2.5/E70	n this PC 01881	N: LM4040	DIM3-2 DIM3-2	2.5 2.5/NOPB	tive):	
Reason for C Manufacturing Anticipated i None Changes to p None Product Affee LM4040AIM3-2 LM4040AIM3-2	hange: Enhancem mpact on roduct ide cted: 2.5 2.5/NOPB -2.5	ent Form, entifica	Fit, Function, Qual ation resulting from LM4040CEM3-2.5/E70 LM4040CEM3-2.5/NOP	n this PC 01881 ⁹ B	N: LM4040 LM4040 LM4040	DIM3-2 DIM3-2 DIM3X	2.5 2.5/NOPB	tive):	
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Reason for C Manufacturing Anticipated i None Changes to p None Product Affee LM4040AIM3-2 LM4040AIM3X LM4040AIM3X LM4040BIM3-2	hange: Enhancem mpact on market roduct ide cted: 2.5 2.5/NOPB -2.5 -2.5/NOPB 2.5 2.5/NOPB	ent Form, entifica	Fit, Function, Qual ation resulting from LM4040CEM3-2.5/E70 LM4040CEM3-2.5/NOP LM4040CIM3-2.5 LM4040CIM3-2.5/NOP LM4040CIM3X-2.5	n this PC 01881 2B B PB	N: LM4040 LM4040 LM4040 LM4040 LM4040 LM4040	DIM3-2 DIM3-2 DIM3X DIM3X EEM3-2 EIM3-2	2.5 2.5/NOPB -2.5 -2.5/NOPB 2.5/NOPB	tive):	
Reason for C Manufacturing Anticipated i None Changes to p None Product Affee LM4040AIM3-2 LM4040AIM3-2 LM4040AIM3X LM4040AIM3X LM4040BIM3-2 LM4040BIM3-2	hange: Enhancem mpact on roduct ide cted: 2.5 2.5/NOPB -2.5 -2.5/NOPB 2.5 2.5/NOPB -2.5 2.5/NOPB -2.5	ent Form, entifica	Fit, Function, Qual ation resulting from LM4040CEM3-2.5/E70 LM4040CEM3-2.5/NOP LM4040CIM3-2.5 LM4040CIM3-2.5/NOP LM4040CIM3X-2.5 LM4040CIM3X-2.5/NOP	m this PC 01881 2B B PB 2B	N: LM4040 LM4040 LM4040 LM4040 LM4040 LM4040	DIM3-2 DIM3-2 DIM3X DIM3X EEM3-2 EIM3-2	2.5 2.5/NOPB -2.5 -2.5/NOPB 2.5/NOPB 2.5 2.5/NOPB	tive):	

Qualification Report

Approve Date 20-July-2020

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

				QBS Product		
Туре	Test Name / Condition	Duration	Qual Vehicle: LM4040AIM3-2.5 (GFAB)	Reference: LM4040AIM3-2.5 (SFAB)	QBS Product Reference: LM4040AIM3-2.5 CTRL (GFAB)	QBS Product Reference: <u>LM4040QCEM3-</u> <u>5.0/NOPB</u>
AC	Autoclave 121C	96 Hours	1/77/0	1/77/0	1/77/0	3/231/0
ED	Electrical Characterization	-	1/30/0	1/30/0	1/30/0	-
ELFR	Early Life Failure Rate, 140C	48 Hours	-	-	-	3/2400/0
CDM	ESD - CDM	750 V	-	-	-	1/3/0
CDM	ESD - CDM	1000 V	-	-	-	1/3/0
HBM	ESD – HBM	2000 V	-	-	-	1/3/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0
HTOL	Life Test, 125C	1000 Hours	1/77/0	1/77/0	1/77/0	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	1/45//0
LU	Latch-up	Per JESD78, 25C	-	-	-	1/6/0
	Latch-up	Per JESD78, 125C				1/6/0
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	1/Pass	1/Pass	1/Pass	-
MSL	Moisture Sensitivity	-	1/12/0	1/12/0	1/12/0	-
TC	Temperature Cycle, -65/150C	500 Cycles	1/77/0	1/77/0	1/77/0	3/231/0
WBP	Bond Pull	Post/T/C	-	-	-	1/5/0
YLD	FTY and Bin Summary	-	1/Pass	1/Pass	1/Pass	-

- QBS: Qual By Similarity

- Qual Device LM4040AIM3-2.5 is gualified at LEVEL1-260C

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours - The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ Green/Pb-free Status: Qualified Pb-Free (SMT) and Green

Qualification Report

Approve Date 20-July-2020

Qualification Results

Туре	Test Name / Condition	Duration	Qual Vehicle: LM4040AIM3-2.5 (SFAB)	QBS Product Reference: LM4040AIM3-2.5 (GFAB)	QBS Product Reference: LM4040AIM3-2.5 CTRL (SFAB)	QBS Product Reference: <u>LM4040QCEM3-</u> <u>5.0/NOPB</u>
AC	Autoclave 121C	96 Hours	1/77/0	1/77/0	1/77/0	3/231/0
ED	Electrical Characterization	-	1/30/0	1/30/0	1/30/0	-
ELFR	Early Life Failure Rate, 140C	48 Hours	-	-	-	3/2400/0
CDM	ESD - CDM	750 V	-	-	-	1/3/0
CDM	ESD - CDM	1000 V	-	-	-	1/3/0
HBM	ESD – HBM	2000 V	-	-	-	1/3/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0
HTOL	Life Test, 125C	1000 Hours	1/77/0	1/77/0	1/77/0	3/231/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	1/45//0
LU	Latch-up	Per JESD78, 25C	-	-	-	1/6/0
	Latch-up	Per JESD78, 125C				1/6/0
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	1/Pass	1/Pass	1/Pass	-
MSL	Moisture Sensitivity	-	1/12/0	1/12/0	1/12/0	-
TC	Temperature Cycle, -65/150C	500 Cycles	1/77/0	1/77/0	1/77/0	3/231/0
WBP	Bond Pull	Post/T/C	-	-	-	1/5/0
YLD	FTY and Bin Summary	-	1/Pass	1/Pass	1/Pass	-

- QBS: Qual By Similarity

- Qual Device LM4040AIM3-2.5 is qualified at LEVEL1-260C

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

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